503970544 08/22/2016

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
FENG-CHENG HSU	08/02/2016
SHUO-MAO CHEN	08/02/2016
JUI-PIN HUNG	08/09/2016
SHIN-PUU JENG	08/02/2016

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LTD.	
Street Address:	NO.8, LI-HSIN RD. 6, HSINCHU SCIENCE PARK	
City:	HSINCHU	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15223356

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NAME OF SUBMITTER:	ANTHONY KING
SIGNATURE:	/Anthony King/
DATE SIGNED:	08/22/2016

Total Attachments: 3

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PATENT 503970544 REEL: 039498 FRAME: 0266

Your Ref.: P20160438US00

US ONLY

ASSIGNMENT

WHEREAS, I(we), <u>HSU. FENG-CHENG</u>, <u>CHEN. SHUO-MAO</u>, <u>HUNG, JUI-PIN</u>, and <u>JENG. SHIN-PUU</u> whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled

SEMICONDUCTOR PACKAGE STRUCTURE AND METHOD FOR MANUFACTURING THE SAME

MANUFACTUR	RING THE SAME	
(hereinafter referred to as the INVENTION) for which an ap is executed on even date herewith unless at least one of th ☐ United States Design Patent was ☐ executed on:	pplication for United States Letters Patent /Utility Paten he following is checked:	
☐ filed on: 29 July 2016 Seri ☐ established by PCT International Patent Application United States of America ☐ issued on as U.S. Patent No		
WHEREAS, TAIWAN SEMICONDUCTOR MANUaddress is NO.8, LI-HSIN RD. 6, HSINCHU Schereinafter referred to as ASSIGNEE, is desirous of acquirithe United States and its territorial accountage.	SCIENCE PARK, HSINCHU, TAIWAN, R.O.	
the United States and its territorial possessions;		
NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term of terms for which the same may be granted, including all priority rights under any International Convention.		
ASSIGNOR further covenants that no assignments, so or entered into which would conflict with this Assignment	sale, agreement or encumbrance has been or will be mant;	
ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said Invention, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said Invention, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the Invention that are within ASSIGNOR's possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR'S obligations under this instrument shall extend to ASSIGNOR's heirs, executors administrators and other legal representatives.		
and all Letters Patent referred to above to ASSIGNEE, as the same, for ASSIGNEE'S sole use and behoof; and for the successors, to the full end of the term for which such Lesame would have been held by ASSIGNOR had this assignment.	he use and behoof of ASSIGNEE'S legal representatives a Letters Patent may be granted, as fully and entirely as	
Assignor Name HSU, FENG-CHENG	Address 3F, 26-2, DAGUAN RD., SANXIA, NEV TAIPEI 237-41, TAIWAN (R.O.C.)	
Signature of Assignor (X) Jeng-Weng Hon	Date of Signature (X) 2016, 8, 2	
Name of Witness (optional)	Name of Witness (optional)	
Signature of Witness (optional)	Signature of Witness (Optional)	

- 1 -

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Signature of Assignor (X) Shub - Man Chen	Date of Signature (X) 20/6. P. >
Name of Wilness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name HUNG, JUI-PIN	Address 10F-2, 58, CHIEN-CHUNG RD. 1, HSINCHU, TAIWAN (R.O.C.)
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Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

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Signature of Assignor (X)	Date of Signature (X) 2016- & 2
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name CHEN, SHUO-MAO	Address 4F., NO.21-3, CHANGSHENG ST., XINZHUANG DIST., NEW TAIPEI CITY 24247, TAIWAN (R.O.C.)
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Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

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Signature of Assignor (X) HMM JMM Name of Witness (optional)	Date of Signature (X) > 0 1 6 / 9 Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

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Signature of Assignor (X)	Date of Signature (X)
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